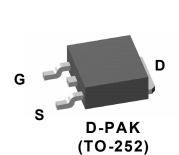
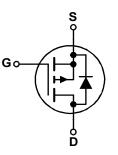
FAIRCHILD FDD4685 40V P-Channel PowerTrench <sup>®</sup> -40V, -32A, 27mΩ	March 2015 MOSFET
Features	General Description
<ul> <li>Max r<sub>DS(on)</sub> = 27mΩ at V<sub>GS</sub> = -10V, I<sub>D</sub> = -8.4A</li> <li>Max r<sub>DS(on)</sub> = 35mΩ at V<sub>GS</sub> = -4.5V, I<sub>D</sub> = -7A</li> <li>High performance trench technology for extremely low r<sub>DS(on)</sub></li> </ul>	This P-Channel MOSFET has been produced using Fairchild Semiconductor's proprietary PowerTrench <sup>®</sup> technology to deliver low $r_{DS(on)}$ and good switching characteristic offering superior performance in application.
RoHS Compliant	Application



Power Supplies



## MOSFET Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted

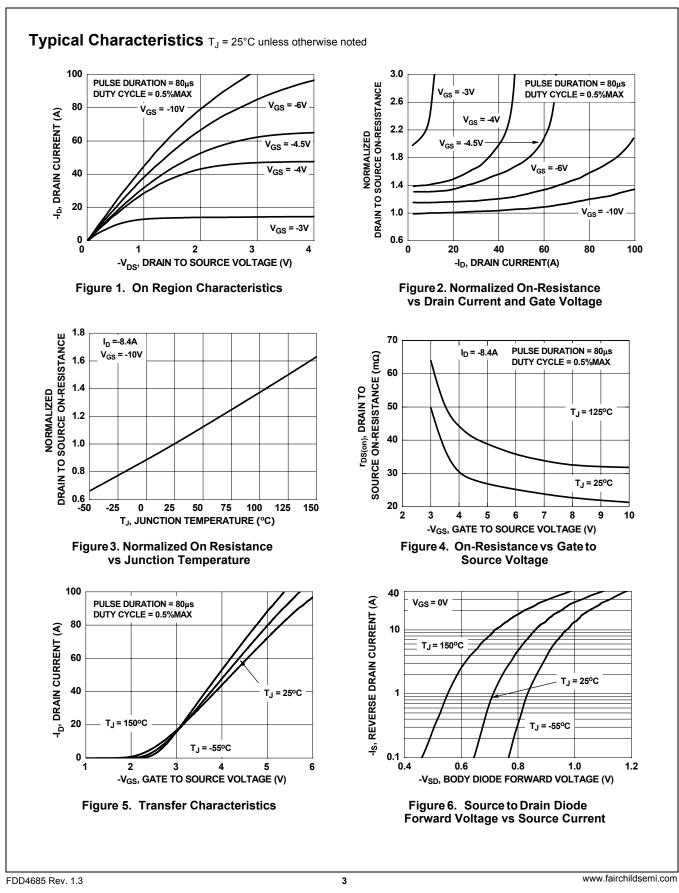
Symbol	Parameter			Ratings	Units	
V <sub>DS</sub>	Drain to Source Voltage			-40	V	
V <sub>GS</sub>	Gate to Source Voltage			±20	V	
I <sub>D</sub>	Drain Current -Continuous(Package Limited)	T <sub>C</sub> = 25°C		-32		
	-Continuous(Silicon Limited)	T <sub>C</sub> = 25°C	(Note 1)	-40		
	-Continuous	T <sub>A</sub> = 25°C	(Note 1a)	-8.4	Α	
	-Pulsed			-100		
E <sub>AS</sub>	Drain-Source Avalanche Energy		(Note 3)	121	mJ	
P <sub>D</sub>	Power Dissipation T <sub>C</sub> = 25°C		69	14/		
	Power Dissipation		(Note 1a)	3	W	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			–55 to +150	°C	

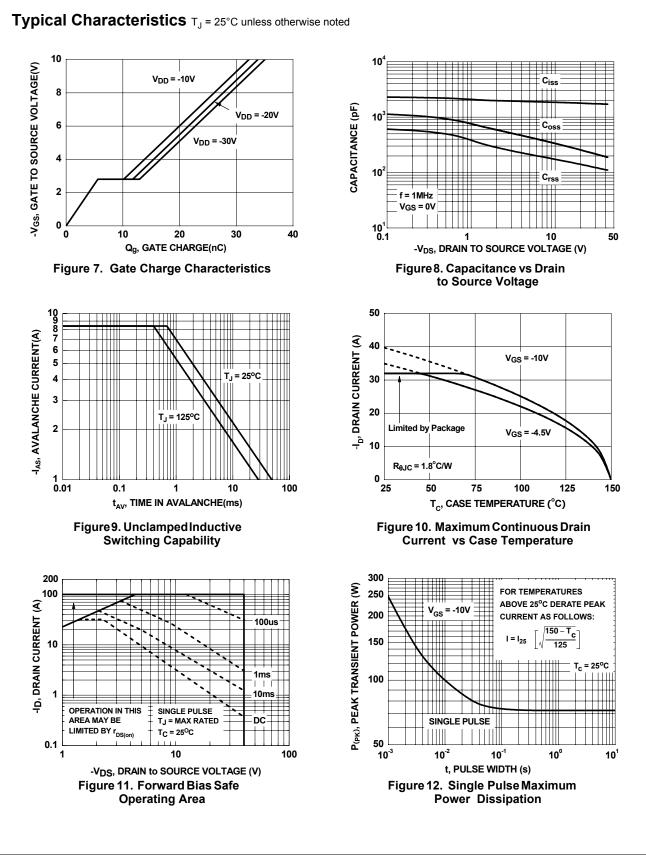
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case		1.8	°C/W
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient (No	ote 1a)	40	C/VV

## **Package Marking and Ordering Information**

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD4685	FDD4685	D-PAK(TO-252)	13"	16mm	2500 units

	acteristics Drain to Source Breakdown Voltage				Max	Units
ΔT <sub>J</sub> I <sub>DSS</sub>	-					
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	_	I <sub>D</sub> = -250μA, V <sub>GS</sub> = 0V	-40			V
	Breakdown Voltage Temperature Coefficient	$I_D = -250 \mu A$ , referenced to 25°C		-33		mV/°C
	Zero Gate Voltage Drain Current	$V_{DS} = -32V, V_{GS} = 0V$			-1	μA
	Gate to Source Leakage Current	$V_{GS} = \pm 20V, V_{GS} = 0V$			±100	nA
On Chara	acteristics (Note 2)			-	•	
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = -250 \mu A$	-1	-1.6	-3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_{I}}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = -250 \mu A$ , referenced to 25°C		4.9		mV/°C
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	$V_{GS} = -10V, I_D = -8.4A$		23	27	
		$V_{GS} = -4.5V, I_D = -7A$		30	35	mΩ
		V <sub>GS</sub> = -10V, I <sub>D</sub> = -8.4A, T <sub>J</sub> =125°C		33	42	
9fs	Forward Transconductance	$V_{DS} = -5V, I_D = -8.4A$		23		S
Dynamic	Characteristics					
C <sub>iss</sub>	Input Capacitance			1790	2380	pF
C <sub>oss</sub>	Output Capacitance	v <sub>DS</sub> = −200, v <sub>GS</sub> = 00, —f = 1MHz		260	345	pF
C <sub>rss</sub>	Reverse Transfer Capacitance			140	205	pF
R <sub>g</sub>	Gate Resistance	f = 1MHz		4		Ω
Switchin	g Characteristics					
t <sub>d(on)</sub>	Turn-On Delay Time			8	16	ns
t <sub>r</sub>	Rise Time	$-V_{DD} = -20V, I_D = -8.4A$ $-V_{GS} = -10V, R_{GEN} = 6\Omega$		15	27	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{\rm GS} = -10V, R_{\rm GEN} = 002$		34	55	ns
	Fall Time			14	26	ns
t <sub>f</sub>		V <sub>DD</sub> =–20V, I <sub>D</sub> = –8.4A		19	27	nC
-	Total Gate Charge					nC
Q <sub>g(TOT)</sub>	Gate to Source Gate Charge	$V_{GS} = -5V$		5.6		
t <sub>f</sub> Q <sub>g(TOT)</sub> Q <sub>gs</sub> Q <sub>gd</sub>	-	V <sub>GS</sub> = -5V		5.6 6.1		nC
Q <sub>g(TOT)</sub> Q <sub>gs</sub> Q <sub>gd</sub>	Gate to Source Gate Charge	V <sub>GS</sub> = -5V				-
Q <sub>g(TOT)</sub> Q <sub>gs</sub> Q <sub>gd</sub>	Gate to Source Gate Charge Gate to Drain "Miller" Charge	$V_{GS} = -5V$ $V_{GS} = 0V, I_S = -8.4A$ (Note 2)			-1.2	-
Q <sub>g(TOT)</sub> Q <sub>gs</sub> Q <sub>gd</sub> Drain-So	Gate to Source Gate Charge Gate to Drain "Miller" Charge urce Diode Characteristics			6.1	-1.2 45	nC

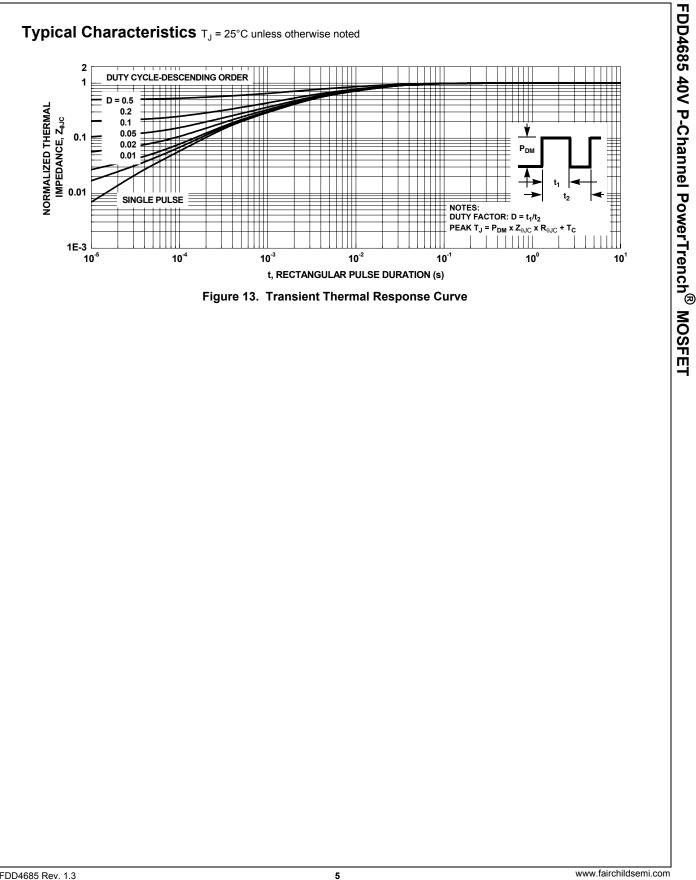




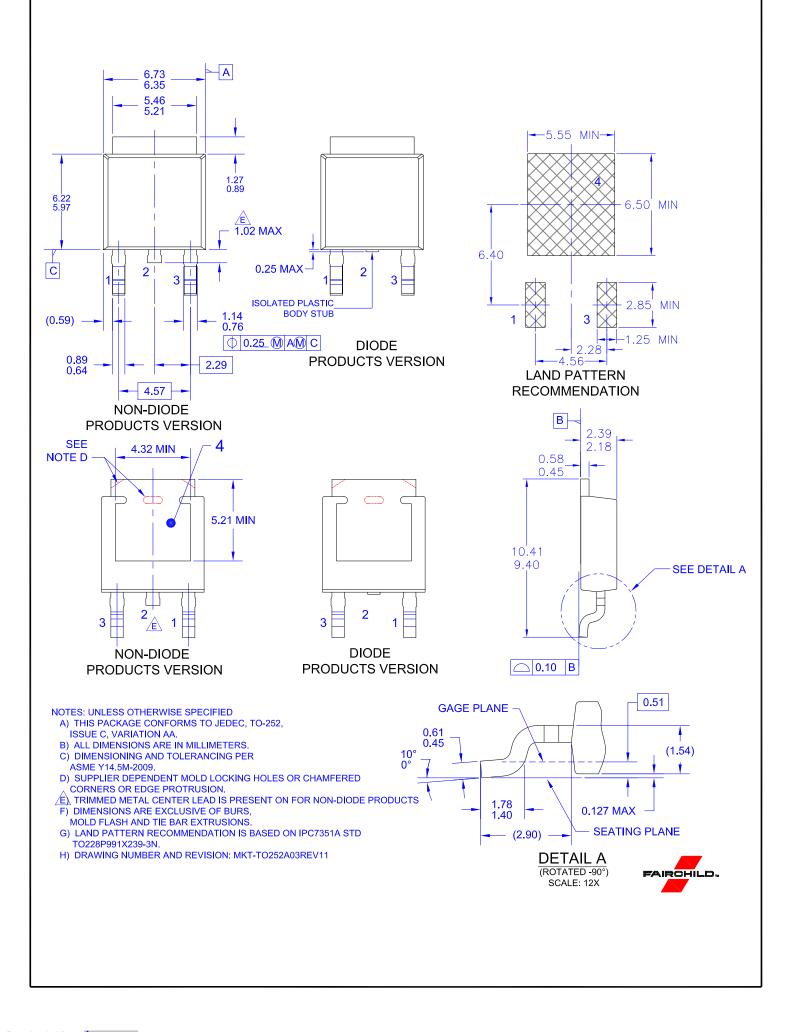
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FDD4685 40V P-Channel PowerTrench<sup>®</sup> MOSFET



FDD4685 Rev. 1.3



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